High Surge MELF Wirewound Resistors



HSMW Series



Features:

- High surge performance
- Compact SMD format
- Flameproof wirewound technology
- UL1412 recognised fusing*
- Failsafe mains fusing at 120 / 240V_{rms}





All parts are Pb-free and comply with EU Directive 2011/65/EU amended by (EU) 2015/863 (RoHS3)

Electrical Data

		HSMW0309
Power rating at 70°C	W	1
5s overload rating	W	6.25
Resistance range	Ω	1R0 to 470R
Resistance tolerance	%	5
TCR	ppm/°C	±200
Standard values		E24 preferred
UL recognised values Ω Any value in the range 1R0 t		Any value in the range 1R0 to 220R is recognised; higher values are not.
Ambient temperature range	nperature range °C -55 to +155	

Physical Data

Dimensions in mm and weight in g				
Туре	L ±0.5	D ±0.3	C min.	Wt. nom.
HSMW0309	9	3.5	1.3	0.28

Construction

A high quality ceramic substrate is assembled with interference fit, tin plated end caps. The resistive element is wound on the substrate and welded to the caps. Cement protection is applied to the resistor body before marking with indelible ink.

Solderability

The pure tin finish produces ageing free contacts on which low melting point solders can be used. Dipped area shall be covered with a smooth and bright solder coating after three seconds immersion at 245°C.

Marking

HSMW resistors are marked with five colour bands on a grey body. The first three bands indicate value and the fourth tolerance in conformance with IEC62. The fifth band is yellow indicating high surge performance.

Solvent Resistance

The component is resistant to all normal industrial cleaning solvents suitable for printed circuits.

^{*} Values ≤220R only, UL file number E234469

High Surge MELF Wirewound Resistors

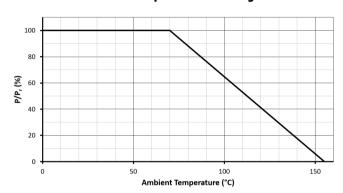




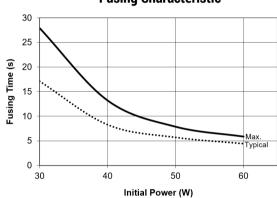
Performance Data

Test	Method		Maximum / Pass Criterion
Load life	1000 hours, cyclic load at 70°C	±∆R%	5
Short term overload	$6.25 \times P_r$ for 5 s	±∆R%	2
Resistance to solder heat	350 ± 10°C, 3 ± 0.5s	±∆R%	1
Long term damp heat	56 days, 40°C/95%RH	±∆R%	5
Temperature cycling	100 cycles, -55 to 155°C	±∆R%	2
Single pulse	See Pulse Energy Limits graph below	±∆R%	5
Surge 1.2/50μs	See Surge Performance graph below	±∆R%	5
Fusing performance	See Fusing Characteristic graph below		
Solderability	245 ± 3°C, 3 ± 0.5s		>95% coverage

Temperature Derating



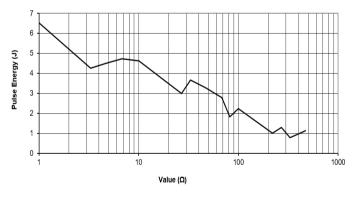
Fusing Characteristic



Note: After fusing the ohmic value is at least 100 times the initial value, provided initial power \geq 30W is applied.

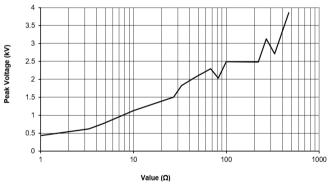
Pulse Energy Limits

(single pulse or low repetition rate, $|\Delta R|$ <5%)



Surge Performance

(1.2/50μs, 10 pulses at 60s intervals, |ΔR|<5%)



Recommended Solder Pads

Dimensions in mm				<i>□</i>	
Туре	Α	В	С	с	
HSMW0309	5.2	3.4	4.2	B A	

Notes:

- 1. For correct fusing operation, avoid close thermal contact between mounting pads and large copper areas.
- 2. A PCB cutout between the mounting pads may be required. See Application Notes.

High Surge MELF Wirewound Resistors



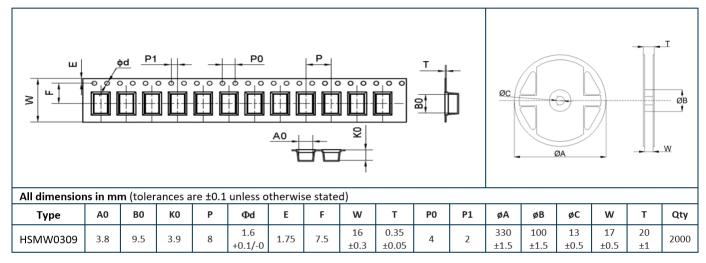


Application Notes

For the purposes of UL approval and safe fusing performance, the following points should be observed:

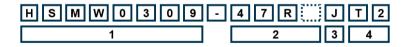
- To protect against fire under all conditions of overload, a positive clearance of 13mm should be provided between the body of the resistor and any combustible materials.
- 2. If a possible failure mode leads to overload below the minimum fusing power or to a maximum fusing time exceeding 5s, then it is strongly recommended that a PCB cutout be provided between the mounting pads in order to avoid overheating of FR4 material.
- A positive clearance of 13mm should be provided between the resistor and uninsulated parts of opposite polarity or uninsulated 3. dead metal parts.
- Limited Short Circuit testing should be performed in the complete appliance.

Packaging



Ordering Procedure

Example: HSMW0309-47RJT2 (47 ohms ±5%, Pb-free)



	1	2	3	4	
	Type	Value	Tolerance	Packing	
ŀ	HSMW0309	E24	J = ±5%	T2 = plastic tape, 2000/reel	
		3/4 characters R = ohms			

© TT Electronics plc